

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Takehiko Sumi	04/05/2007
Hideo Watanabe	04/05/2007
RECEIVING PARTY DATA	
Name:	Kyoraku Co., Ltd.
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City:	Tokyo
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PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	11680002
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ATTORNEY DOCKET NUMBER:	KYF0033-US
NAME OF SUBMITTER:	Andrew P. Cernota
Total Attachments: 2 source=Assignment#page1.tif source=Assignment#page2.tif	

OP \$40.00 11680002

ASSIGNMENT OF PATENT APPLICATION

Whereas the undersigned inventors, TAKEHIKO SUMI, HIDEO WATANABE, have invented certain new and useful improvements as set forth in the patent application entitled:

PROPYLENE RESIN COMPOSITION, BLOW MOLDED PANEL COMPRISED OF THE COMPOSITION, AND AUTOMOBILE DECK BOARD COMPRISED OF THE BLOW MOLDED PANEL

For which we have executed an application for a United States Letters Patent as inventors (and we hereby authorize our attorneys to prosecute said application and to here insert filing date and serial number of the application when known, Serial No. 11/1080,002, filed on the 28th day of February 2006)

For good and valuable consideration, receipt of which is hereby acknowledged, undersigned inventors hereby:

- 1) Sell(s), assign(s) and transfer(s) to Kyoraku Co., Ltd., a Japanese corporation having a place of business at 12-15, Kobunacho, Nihonbashi, Chuo-Ku, Tokyo 103-0024, Japan, (hereinafter referred to as ASSIGNEE) the entire right, title, and interest as inventors in any and all improvements and inventions disclosed in, applications(s) based upon, and Patent(s) (including foreign patents and all my rights under the International Convention for the Protection of Industrial Property and all other treaties of like purpose) granted upon information which is disclosed in the above referenced application.
- 2) Authorize and request the Commissioner of Patents of the United States of America and corresponding Officer of each country foreign thereto to issue any and all Letters Patents resulting from said application or any division(s), continuation(s), substitute(s), or reissue(s) thereof to the ASSIGNEE.
- 3) Agree to execute all papers and documents, and perform any acts which are reasonably necessary in connection with the prosecution of said application, as well as any derivative and applications thereof, foreign applications based thereon, and/or the enforcement of patents resulting from such applications.
- 4) Agree that the terms, covenants and conditions of this assignment shall inure to the benefit of the ASSIGNEE, its successors, assigns, and other legal representative, and shall be binding upon the inventors, as well as the inventor's heirs, legal representatives, and assigns.
- 5) Warrant and represent that we have not entered, and will not enter into any assignment, contract, or understanding that conflicts with this assignment.

(Signatures of the inventors appear on the following attached page.)

KYF-0033-US

Signed on the date(s) indicated beside my signature:

INVENTORS

DATE SIGNED

WITNESS

Takehiko Sumi
Takehiko SUMI

05/04/2007
Date

Hideo Watanabe
Hideo WATANABE

05/04/2007
Date
